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9671 Light-Curable LCP Adhesive

# **APPLICATIONS**

- · Microspeaker Membranes to Housings
- LCP Bonding

# **FEATURES**

• UV/Visible Light Cure

ASTM E831

- Red Color .
- **Highly Thixotropic** .
- Halogen-Free

# **BENEFITS**

- · Cures in Seconds
- Enhanced Visibility •
- High Bead Profile for Enhanced • Coverage

**ROPERTIES** \*

Dymax 9671 cures upon exposure to light and is designed for rapid bonding of liquid crystal polymer (LCP). Dymax materials contain no nonreactive solvents and cure upon exposure to light. Their ability to cure in seconds enables faster processing, greater output, and lower processing costs. When cured with Dymax lightcuring spot lamps, focused-beam lamps, or flood lamps, they deliver optimum speed and performance for bonding LCP. Dymax lamps offer the optimum balance of UV and visible light for the fastest, deepest cures. This product is in full compliance with RoHS directives 2015/863/EU.

UNCURED PROPERTIES *			ELECTRICAL PI
Property	Value	Test Method	Property
Solvent Content	No Nonreactive Solvents	N/A	Dielectric Const
Chemical Class	Acrylated Urethane	N/A	Dissipation Fact
Appearance	Pink Transparent Gel	N/A	Dielectric Break
Soluble in	Organic Solvents	N/A	kV/mm [V/mil]
Density, g/ml	1.03	ASTM D1875	Volume Resistiv
Viscosity, cP (20 rpm)	45,000 (nominal)	ASTM D2556	Surface Resistiv
Shelf Life at Recommended Conditions from Date of	12 months	N/A	ADHESION
Manufacture		N/A	Substrate
	E0 *		ABS acrylonitrile
CURED MECHANICAL PROPERTI			
CURED MECHANICAL PROPERTI Property	ES * Value	Test Method	EVA ethylene-vi
		Test Method ASTM D2240	EVA ethylene-vi LCP liquid cryst
Property	Value		EVA ethylene-vin LCP liquid crysta LDPE low-densi
Property Durometer Hardness	Value D55	ASTM D2240	EVA ethylene-vi LCP liquid cryst LDPE low-densi PA polyamide
Property Durometer Hardness Tensile at Break, MPa [psi] Elongation at Break, %	Value   D55   15.8 [2,100]	ASTM D2240 ASTM D638	EVA ethylene-vi LCP liquid cryst LDPE low-densi PA polyamide PBT poly(butyle
Property Durometer Hardness Tensile at Break, MPa [psi]	Value   D55   15.8 [2,100]   200	ASTM D2240 ASTM D638 ASTM D638	EVA ethylene-vii LCP liquid cryst LDPE low-densi PA polyamide PBT poly(butyle PC polycarbonat
Property Durometer Hardness Tensile at Break, MPa [psi] Elongation at Break, % Modulus of Elasticity, MPa [psi]	Value   D55   15.8 [2,100]   200   179.2 [26,000]	ASTM D2240 ASTM D638 ASTM D638 ASTM D638	ABS acrylonitrile EVA ethylene-vin LCP liquid crysta LDPE low-densit PA polyamide PBT poly(butyle PC polycarbonat PET poly(ethylen PI polyimide

OTHER CURED PROPERTIES *		
Property	Value	Test Method
Refractive Index (20° C)	N/A	ASTM D542
Boiling Water Absorption, % (2 h)	6.0	ASTM D570
Water Absorption, % (25°C, 24 h)	5.7	ASTM D570
Linear Shrinkage, %	2.3	ASTM D2566

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Property	Value	Test Method		
Dielectric Constant (1 MHz)	3.27	ASTM D150		
Dissipation Factor (1 MHz)	0.046	ASTM D150		
Dielectric Breakdown Voltage, kV/mm [V/mil]	500	ASTM D149		
Volume Resistivity, ohm-cm	555	ASTM D257		
Surface Resistivity, ohm	6,300	ASTM D257		
ADHESION				
Substrate		Recommendation		
ABS acrylonitrile-butadiene-styrene		~		
EVA ethylene-vinyl acetate		0		
LCP liquid crystal polymer		0		
LDPE low-density polyethylene		0		
PA polyamide		~		
PBT poly(butylene terephthalate)		0		
PC polycarbonate		~		
PET poly(ethylene terephthalate)		0		
PI polyimide		~		
PMMA poly(methyl methacrylate)		0		
PU polyurethane		~		
PVC poly(vinyl chloride)		~		
GL glass		0		
AL aluminum		0		
CU Copper		0		
SS stainless steel		0		

o Limited Applications Recommended

st Requires Surface Treatment (e.g. plasma, corona treatment, etc.)



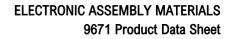
\* Not Specifications N/A Not Applicable

CTEa2 µm/m/°C

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Technical Data Collected PRIOR TO 2013 Rev.02/10/2023





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# **CURING GUIDELINES**

Dymax Curing System (Intensity)	Fixture Time or Belt Speed
2000-EC (50 mW/cm <sup>2</sup> ) <sup>B</sup>	<1 s
5000-EC (200 mW/cm <sup>2</sup> ) <sup>B</sup>	<1 s
BlueWave® 200 (10 W/cm <sup>2</sup> ) <sup>B</sup>	.2 s
UVCS Conveyor with 5000-EC (200 mW/cm <sup>2</sup> ) <sup>D</sup>	7.9 m/min [26 ft/min]
UVCS Conveyor with Fusion F300S (2.5 $\rm W/cm^2)^D$	8.2 m/min [27 ft/min]

Fixture time is defined as the time to develop a shear strength of 0.1 N/mm<sup>2</sup> [10 psi] between glass slides. Actual cure time typically is 3-to-5 times fixture time.

A Fixture times/belt speeds are typical for curing thin films through 100% UV and light-transmitting substrates. Light-obstructing substrates may require longer cure times.

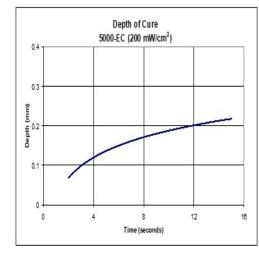
B Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 50 Radiometer.

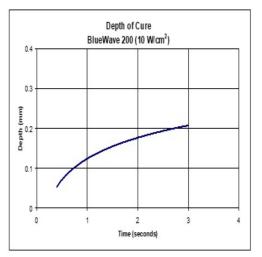
c Intensity was measured over the UVA/Visible range (350-450 nm) using a Dymax ACCU-CAL™ 50-LED Radiometer.

p At 53 mm [2.1 in] focal distance. Maximum speed of conveyor is 8.2 m/min [27 ft/min]. Intensity was measured over the UVA range (320-395 nm) using the Dymax ACCU-CAL™ 150 Radiometer.

### **DEPTH OF CURE**

The graphs below show the increase in depth of cure as a function of exposure time with two different lamps at different intensities. A 9.5 mm [0.37 in] diameter specimen was cured in a polypropylene mold and cooled to room temperature. It was then released from the mold and the cure depth was measured.





#### **OPTIMIZING PERFORMANCE AND HANDLING**

- 1. This product cures with exposure to UV and visible light. Exposure to ambient and artificial light should be kept to a minimum before curing. Dispensing components including needles and fluid lines should be 100% light blocking, not just UV blocking.
- 2. All surfaces in contact with the material should be clean and free from flux residue, grease, mold release, or other contaminants prior to dispensing the material.
- 3. Cure speed is dependent upon many variables, including lamp intensity, distance from the light source, required depth of cure, thickness, and percent light transmission of components between the material and light source.
- 4. Oxygen in the atmosphere may inhibit surface cure. Surfaces exposed to air may require high-intensity (>100 mW/cm<sup>2</sup>) UV light to produce a dry surface cure. Flooding the curing area with an inert gas, such as nitrogen, can also reduce the effects of oxygen inhibition.
- 5. Parts should be allowed to cool after cure before testing and subjecting to any loads or electrical testing.
- 6. In rare cases, stress cracking may occur in assembled parts. Three options may be explored to eliminate this problem. One option is to heat anneal the parts to remove molded-in stresses. A second option is to open any gap between mating parts to reduce stress caused by an interference fit. The third option is to minimize the amount of time the liquid material remains in contact with the substrate(s) prior to curing.
- 7. Light curing generally produces some heat. If necessary, cooling fans can be placed in the curing area to reduce the heating effect on components.
- 8. At the point of curing, an air exhaust system is recommended to dissipate any heat and vapors formed during the curing process.

# ELECTRONIC ASSEMBLY MATERIALS 9671 Product Data Sheet

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# **DISPENSING SUPPORT**

The Dymax Application Engineering team is ready to discuss your application requirements to provide the most appropriate dispensing and/or spraying solution. Visit our current dispensing equipment portfolio here or consult our global contact phone numbers and online chat feature (available in North America only) during normal business hours for instant support.

## STORAGE AND SHELF LIFE

Store the material in a cool, dark place when not in use. Do not expose to light. This product may polymerize upon prolonged exposure to ambient and artificial light. Keep covered when not in use. This material shelf life noted on page 1 of this document, when stored between 10°C (50°F) and 32°C (90°F) in the original, unopened container. 9671 may crystallize after exposure to cold temperatures. If crystallization occurs, the material should be heated to room temperature prior to use. Please contact Dymax Application Engineering if you need further assistance.

#### **CLEAN UP**

Uncured material may be removed from dispensing components and parts with organic solvents. Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods of removal.

## **GENERAL INFORMATION**

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from skin with soap and water. Never use organic solvents to remove material from skin and eyes. For more information on the safe handling of this material, please refer to the Safety Data Sheet before use.

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